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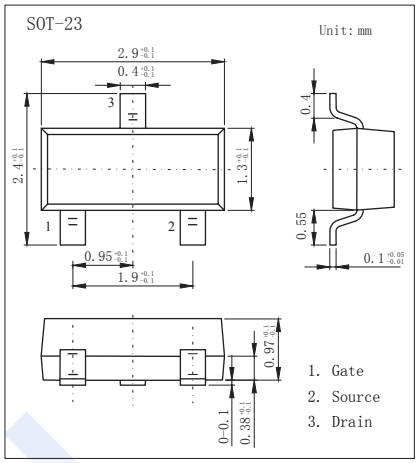
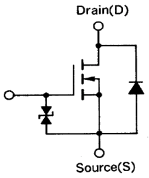


■ Features

- $V_{DS\ (V)}$ = 100V
- I_D = 0.1 A
- $R_{DS(ON)}$ < 30Ω (V_{GS} = 4V)
- $R_{DS(ON)}$ < 25Ω (V_{GS} = 10V)



■ Absolute Maximum Ratings Ta = 25℃

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	100	V
Gate-Source Voltage	V_{GS}	±20	
Continuous Drain Current	I_D	100	mA
Pulsed Drain Current (Note.1)	I_{DM}	200	
Power Dissipation	P_D	200	mW
Junction Temperature	T_J	150	℃
Storage Temperature Range	T_{stg}	-55 to 150	

Note.1: PW ≤ 10ms,Duty Cycle ≤ 50%

■ Electrical Characteristics Ta = 25℃

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V_{DSS}	I_D=250μA, V_{GS}=0V	100			V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=100V, V_{GS}=0V			1	uA
Gate-Body Leakage Current	I_{GSS}	V_{DS}=0V, V_{GS}=±20V			±1	uA
Gate Cut-off Voltage	$V_{GS(off)}$	V_{DS}=5 V I_D=1uA	0.8		1.8	V
Static Drain-Source On-Resistance	$R_{DS(ON)}$	V_{GS}=4V, I_D=10m A			30	Ω
		V_{GS}=10V, I_D=10m A			25	
Forward Transconductance	g_{FS}	V_{DS}=5V, I_D=10m A	20	38		mS
Input Capacitance	C_{iss}	V_{GS}=0V, V_{DS}=5V, f=1MHz		16		pF
Output Capacitance	C_{oss}			12		
Reverse Transfer Capacitance	C_{rss}			3		
Turn-On DelayTime	$t_{d(on)}$	$V_{GS(on)}$=5V, V_{DS}=5V, I_D=10mA, R_L=500Ω, R_G=10Ω		17		ns
Turn-On Rise Time	t_r			10		
Turn-Off DelayTime	$t_{d(off)}$			68		
Turn-Off Fall Time	t_f			38		

■ Marking

Marking	G17

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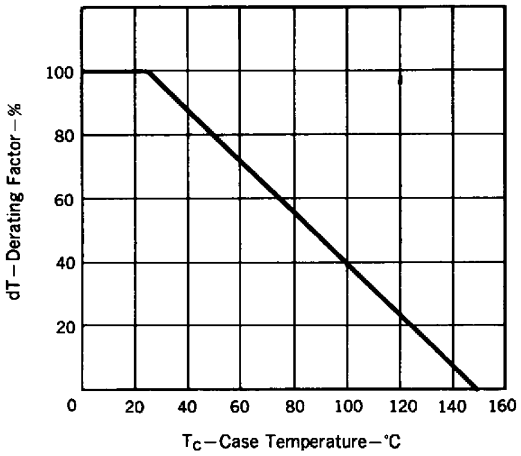
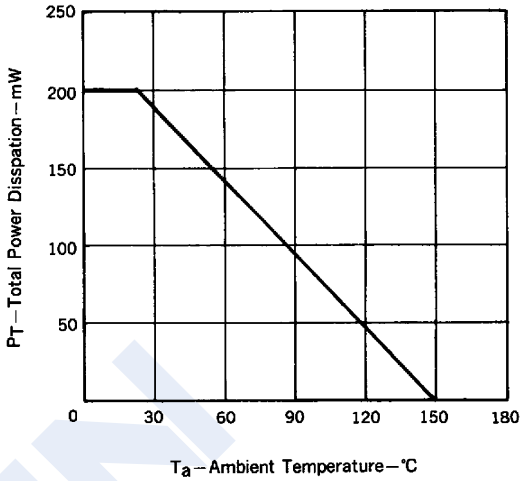
■ Typical Characterisitics

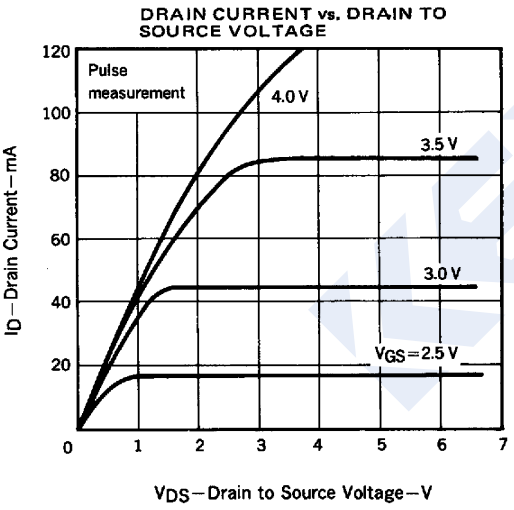
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



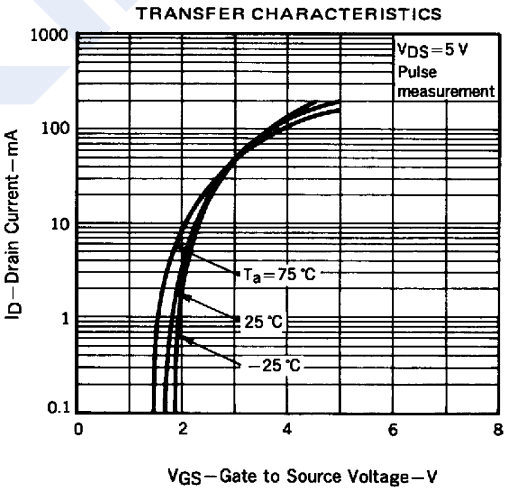
TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE



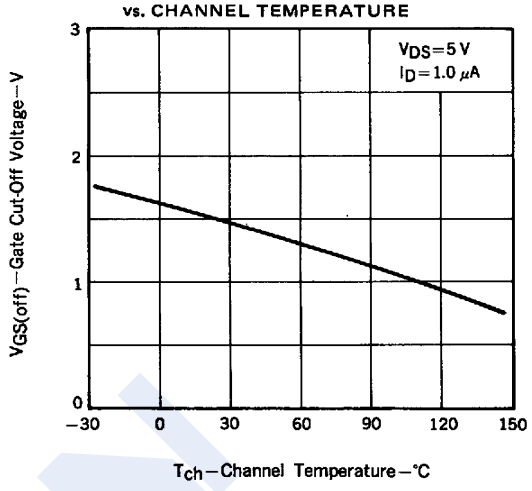
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



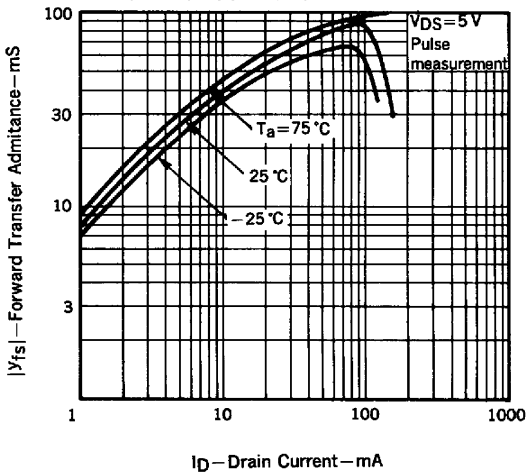
TRANSFER CHARACTERISTICS



GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE



FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



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■ Typical Characterisitics